

# Low-Voltage, Dual Supply, Low $R_{ON}$ , Quad SPST Analog Switches

## DESCRIPTION

The DG9424, DG9425, DG9426 are low voltage precision monolithic quad single-pole-single-throw analog switches.

Using BiCMOS wafer fabrication technology allows the DG9424, DG9425, DG9426 to operate on single and dual supplies. Single supply voltage ranges from 3 to 12 V while dual supply operation is recommended with  $\pm 3$  to  $\pm 6$  V.

Combining high speed ( $t_{ON}$ : 42 ns), flat  $R_{DS(on)}$  over the analog signal range ( $\Omega$ ), minimal insertion lose ( $-3$  dB at 190 MHz), and excellent crosstalk and off-isolation performance, the DG9424, DG9425, DG9426 are ideally suited for audio and video signal switching.

The DG9424 and DG9425 respond to opposite control logic as shown in the Truth Table. The DG9426 has two normally open and two normally closed switches.

## FEATURES

- 2.7 V thru 12 V single supply or  $\pm 3$  thru  $\pm 6$  dual supply
- On-resistance -  $R_{DS(on)}$ : 1.7  $\Omega$
- Fast switching -  $t_{ON}$ : 42 ns  
-  $t_{OFF}$ : 28 ns
- TTL, CMOS compatible
- Low leakage: 0.2 nA
- 2000 V ESD protection

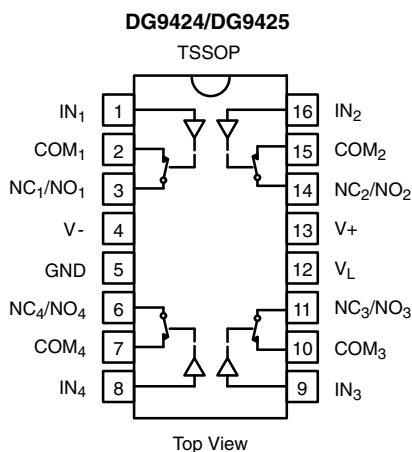
## BENEFITS

- Widest dynamic range
- Low signal errors and distortion
- Break-before-make switching action
- Simple interfacing

## APPLICATIONS

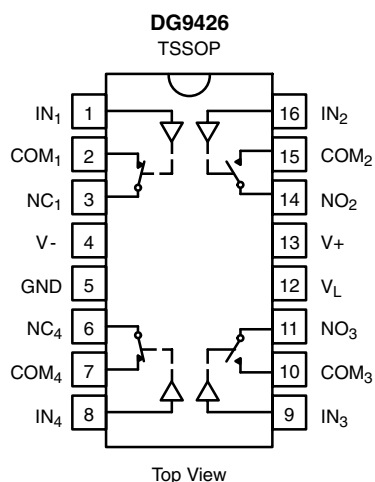
- Automatic test equipment
- Data acquisition systems
- Communication systems
- ADC systems
- xDSL and PBX/PABX
- Audio signal routing

## FUNCTIONAL BLOCK DIAGRAM AND PIN CONFIGURATION



TRUTH TABLE		
Logic	DG9424	DG9425
0	OFF	ON
1	ON	OFF

## FUNCTIONAL BLOCK DIAGRAM AND PIN CONFIGURATION



TRUTH TABLE		
Logic	SW <sub>1</sub> , SW <sub>4</sub>	SW <sub>2</sub> , SW <sub>3</sub>
0	ON	OFF
1	OFF	ON

ORDERING INFORMATION		
Temp. Range	Package	Part Number
DG9424, DG9425		
- 40 °C to 85 °C	16-Pin TSSOP	DG9424DQ
		DG9425DQ
DG9426		
- 40 °C to 85 °C	16-Pin TSSOP	DG9426DQ

ABSOLUTE MAXIMUM RATINGS			
Parameter		Limit	Unit
V <sub>+</sub> to V <sub>-</sub>		- 0.3 to 13	V
GND to V <sub>-</sub>		7	
V <sub>L</sub>		(GND - 0.3) to (V <sub>+</sub> ) + 0.3	
IN, COM, NC, NO <sup>a</sup>		- 0.3 to (V <sub>+</sub> + 0.3)	
Continuous Current (NO, NC, COM Pins)		100	mA
Peak Current, S or D (Pulsed 1 ms, 10 % Duty Cycle)		200	
Storage Temperature		- 65 to 150	°C
Power Dissipation (Package) <sup>b</sup>	16-Pin TSSOP <sup>c</sup>	450	mW
Thermal Resistance <sup>b</sup>		178	°C/W

### Notes:

- Signals on NC, NO, COM or IN exceeding V<sub>+</sub> or V<sub>-</sub> will be clamped by internal diodes. Limit forward diode current to maximum current ratings.
- All leads welded or soldered to PC board.
- Derate 7 mW/°C above 25 °C.



SPECIFICATIONS <sup>a</sup> Single Supply 12 V							
Parameter	Symbol	Test Conditions Unless Specified V <sub>+</sub> = 12 V, V <sub>-</sub> = 0 V V <sub>L</sub> = 5 V, V <sub>IN</sub> = 2.4 V, 0.8 V <sup>f</sup>	Temp. <sup>b</sup>	Limits - 40 °C to 85 °C			Unit
				Min. <sup>d</sup>	Typ. <sup>c</sup>	Ma.x <sup>d</sup>	
Analog Switch							
Analog Signal Range <sup>e</sup>	V <sub>ANALOG</sub>		Full	0		12	V
On-Resistance	R <sub>ON</sub>	V <sub>+</sub> = 10.8 V, V <sub>-</sub> = 0 V I <sub>NO</sub> , I <sub>NC</sub> = 50 mA, V <sub>COM</sub> = 2/9 V	Room Full		1.8	3 4	Ω
Digital Control							
Input Current	I <sub>INL</sub> or I <sub>INH</sub>		Full	- 1	0.01	1	μA
Dynamic Characteristics							
Turn-On Time <sup>e</sup>	t <sub>ON</sub>	R <sub>L</sub> = 300 Ω, C <sub>L</sub> = 35 pF V <sub>NO</sub> , V <sub>NC</sub> = 5 V, See Figure 2	Room Full		42	57 65	ns
Turn-Off Time <sup>e</sup>	t <sub>OFF</sub>		Room Full		28	42 44	
Break-Before-Make Time Delay <sup>e</sup>	t <sub>D</sub>	DG9426 Only, V <sub>NO</sub> , V <sub>NC</sub> = 5 V R <sub>L</sub> = 300 Ω, C <sub>L</sub> = 35 pF	Room	2			
Charge Injection <sup>e</sup>	Q <sub>INJ</sub>	V <sub>g</sub> = 0 V, R <sub>g</sub> = 0 Ω, C <sub>L</sub> = 1 nF	Room		38		pC
Off-Isolation <sup>e</sup>	OIRR	R <sub>L</sub> = 50 Ω, C <sub>L</sub> = 5 pF f = 1 MHz	Room		- 56		dB
Channel-to-Channel Crosstalk <sup>e</sup>	X <sub>TALK</sub>		Room		- 77		
NO, NC Off Capacitance <sup>e</sup>	C <sub>NO(off)</sub> C <sub>NC(off)</sub>	f = 1 MHz	Room		49		pF
COM Off Capacitance <sup>e</sup>	C <sub>COM(off)</sub>		Room		37		
Channel On Capacitance <sup>e</sup>	C <sub>COM(on)</sub>		Room		89		
Power Supplies							
Positive Supply Current	I <sub>+</sub>	V <sub>IN</sub> = 0 or V <sub>L</sub>	Room Full		0.02	1 5	μA
Negative Supply Current	I <sub>-</sub>		Room Full	- 1 - 5	- 0.002		
Logic Supply Current	I <sub>L</sub>		Room Full		0.002	1 5	
Ground Current	I <sub>GND</sub>		Room Full	- 1 - 5	- 0.002		

SPECIFICATIONS <sup>a</sup> Dual Supply ± 5 V							
Parameter	Symbol	Test Conditions Unless Specified V+ = 5 V, V- = 5 V VL = 5 V, VIN = 2.4 V, 0.8 V <sup>f</sup>	Temp. <sup>b</sup>	Limits - 40 °C to 85 °C			Unit
				Min. <sup>d</sup>	Typ. <sup>c</sup>	Max. <sup>d</sup>	
Analog Switch							
Analog Signal Range <sup>e</sup>	VANALOG		Full	- 5		5	V
On-Resistance	RON	V+ = 4.5 V, V- = - 4.5 V INO, INC = 50 mA, VCOM = ± 3.5 V	Room Full		2	3.3 4.3	Ω
Switch Off Leakage Current	INO(off) INC(off)	V+ = 5.5 V, V- = - 5.5 V VCOM = ± 4.5 V, VNO, VNC = ± 4.5 V	Room Full	- 1 - 10		1 10	nA
	ICOM(off)		Room Full	- 1 - 10		1 10	
Channel On Leakage Current	ICOM(on)	V+ = 5.5 V, V- = - 5.5 V, VNO, VNC = VCOM = ± 4.5 V	Room Full	- 1 - 10		1 10	
Digital Control							
Input Current <sup>a</sup>	IINL or IINH		Full	- 1	0.05	1	μA
Dynamic Characteristics							
Turn-On Time <sup>e</sup>	tON	RL = 300 Ω, CL = 35 pF VNO, VNC = ± 3.5 V, See Figure 2	Room Full		56	74 81	ns
Turn-Off Time <sup>e</sup>	tOFF		Room Full		42	64 67	
Break-Before-Make Time Delay <sup>e</sup>	tD	DG9426 Only, VNO, VNC = 3.5 V RL = 300 Ω, CL = 35 pF	Room	2			
Charge Injection <sup>e</sup>	QINJ	Vg = 0 V, Rg = 0 Ω, CL = 1 nF	Room		112		pC
Off Isolation <sup>e</sup>	OIRR	RL = 50 Ω, CL = 5 pF, f = 1 MHz	Room		- 56		dB
Channel-to-Channel Crosstalk <sup>e</sup>	XTALK		Room		- 82		
Source Off Capacitance <sup>e</sup>	CNO(off) CNC(off)	f = 1 MHz	Room		38		pF
Drain Off Capacitance <sup>e</sup>	CCOM(off)		Room		38		
Channel On Capacitance <sup>e</sup>	CCOM(on)		Room		89		
Power Supplies							
Positive Supply Current <sup>e</sup>	I+	VIN = 0 or VL	Room Full		0.03	1 5	μA
Negative Supply Current <sup>e</sup>	I-		Room Full	- 1 - 5	- 0.002		
Logic Supply Current <sup>e</sup>	IL		Room Full		0.002	1 5	
Ground Current <sup>e</sup>	IGND		Room Full	- 1 - 5	- 0.002		



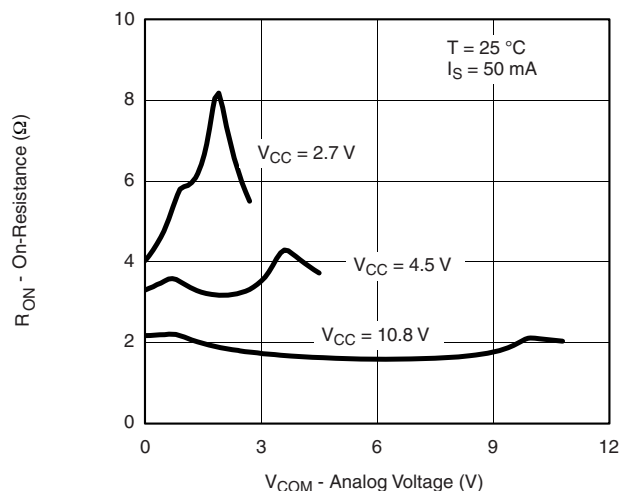
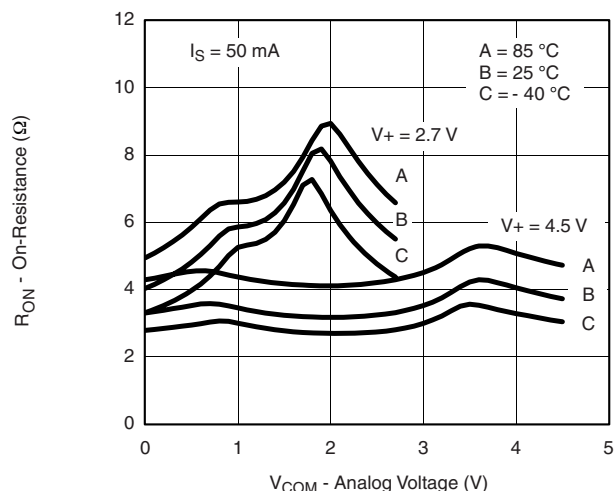
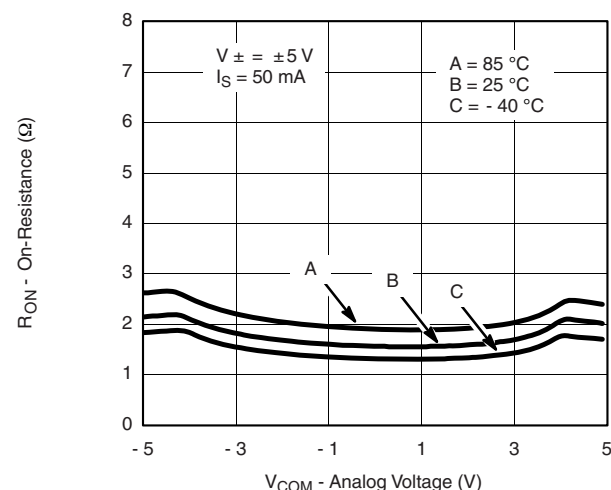
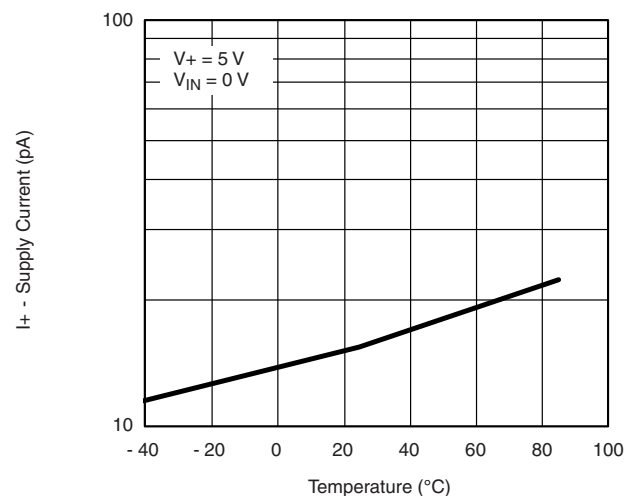
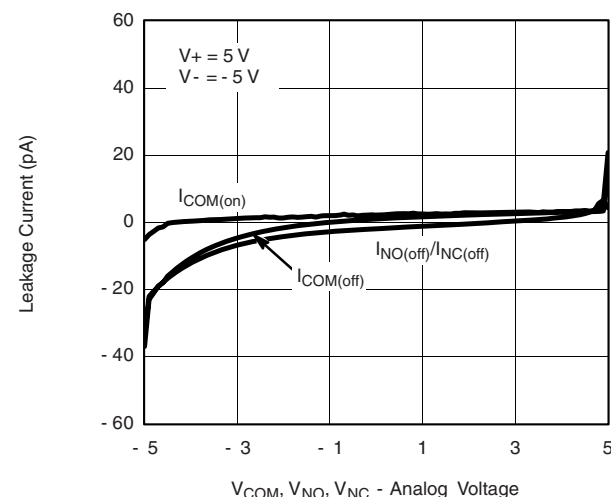
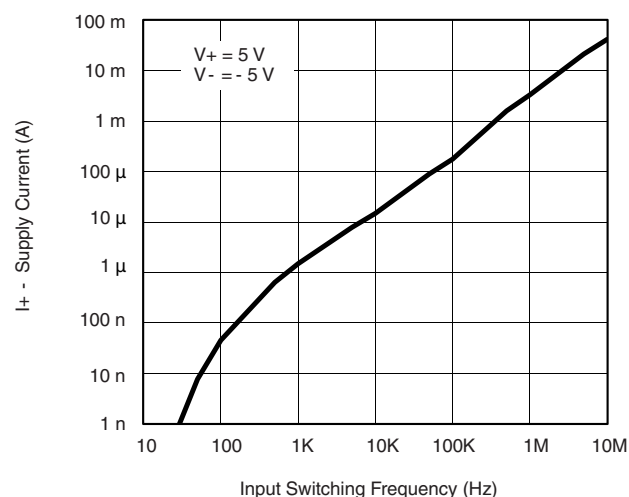
SPECIFICATIONS <sup>a</sup> Single Supply 5 V							
Parameter	Symbol	Test Conditions Unless Specified V <sub>+</sub> = 5 V, V <sub>-</sub> = 0 V V <sub>L</sub> = 5 V, V <sub>IN</sub> = 2.4 V, 0.8 V <sup>f</sup>	Temp. <sup>b</sup>	Limits - 40 °C to 85 °C			Unit
				Min. <sup>d</sup>	Typ. <sup>c</sup>	Max. <sup>d</sup>	
Analog Switch							
Analog Signal Range <sup>e</sup>	V <sub>ANALOG</sub>		Full			5	V
On-Resistance <sup>e</sup>	R <sub>ON</sub>	V <sub>+</sub> = 4.5 V, I <sub>NO</sub> , I <sub>NC</sub> = 50 mA V <sub>COM</sub> = 1 V, 3.5 V	Room Full		3.4	4.8 5.8	Ω
Dynamic Characteristics							
Turn-On Time <sup>e</sup>	t <sub>ON</sub>	R <sub>L</sub> = 300 Ω, C <sub>L</sub> = 35 pF V <sub>NO</sub> , V <sub>NC</sub> = 3.5 V, See Figure 2	Room Hot		71	86 106	ns
Turn-Off Time <sup>e</sup>	t <sub>OFF</sub>		Room Hot		37	51 56	
Break-Before-Make Time Delay <sup>e</sup>	t <sub>D</sub>	DG9426 Only, V <sub>NO</sub> , V <sub>NC</sub> = 3.5 V R <sub>L</sub> = 300 Ω, C <sub>L</sub> = 35 pF	Room	5			
Charge Injection <sup>e</sup>	Q <sub>INJ</sub>	V <sub>g</sub> = 0 V, R <sub>g</sub> = 0 Ω, C <sub>L</sub> = 1 nF	Room		10		pC
Power Supplies							
Positive Supply Current <sup>e</sup>	I <sub>+</sub>	V <sub>IN</sub> = 0 or V <sub>L</sub>	Room Hot		0.02	1 5	μA
Negative Supply Current <sup>e</sup>	I <sub>-</sub>		Room Hot	- 1 - 5	- 0.002		
Logic Supply Current <sup>e</sup>	I <sub>L</sub>		Room Hot		0.002	1 5	
Ground Current <sup>e</sup>	I <sub>GND</sub>		Room Hot	- 1 - 5	- 0.002		

SPECIFICATIONS <sup>a</sup> Single Supply 3 V							
Parameter	Symbol	Test Conditions Unless Specified V <sub>+</sub> = 3 V, V <sub>-</sub> = 0 V V <sub>L</sub> = 3 V, V <sub>IN</sub> = 2.4 V, 0.4 V <sup>f</sup>	Temp. <sup>b</sup>	Limits - 40 °C to 85 °C			Unit
				Min. <sup>d</sup>	Typ. <sup>c</sup>	Max. <sup>d</sup>	
Analog Switch							
Analog Signal Range <sup>e</sup>	V <sub>ANALOG</sub>		Full	0		3	V
On-Resistance	R <sub>ON</sub>	V <sub>+</sub> = 2.7 V, V <sub>-</sub> = 0 V I <sub>NO</sub> , I <sub>NC</sub> = 5 mA, V <sub>COM</sub> = 0.5, 2.2 V	Room Full		8	13.8 15.1	Ω
Switch Off Leakage Current <sup>a</sup>	I <sub>NO(off)</sub> I <sub>NC(off)</sub>	V <sub>+</sub> = 3.3 V, V <sub>-</sub> = 0 V V <sub>COM</sub> = 0.3, 3 V, V <sub>NO</sub> , V <sub>NC</sub> = 3, 0.3 V	Room Full	- 1 - 10		1 10	nA
	I <sub>COM(off)</sub>		Room Full	- 1 - 10		1 10	
Channel On Leakage Current <sup>a</sup>	I <sub>COM(on)</sub>	V <sub>+</sub> = 3.3 V, V <sub>-</sub> = 0 V, V <sub>NO</sub> , V <sub>NC</sub> = V <sub>COM</sub> = 0.3, 3 V	Room Full	- 1 - 10		1 10	
Digital Control <sup>e</sup>							
Input Current	I <sub>INL</sub> or I <sub>INH</sub>		Full	- 1	0.005	1	μA
Dynamic Characteristics							
Turn-On Time	t <sub>ON</sub>	R <sub>L</sub> = 300 Ω, C <sub>L</sub> = 35 pF V <sub>NO</sub> , V <sub>NC</sub> = 1.5 V, See Figure 2	Room Full		140	163 193	ns
Turn-Off Time	t <sub>OFF</sub>		Room Full		65	80 89	
Break-Before-Make Time Delay	t <sub>D</sub>	DG9426 Only, V <sub>NO</sub> , V <sub>NC</sub> = 1.5 V R <sub>L</sub> = 300 Ω, C <sub>L</sub> = 35 pF	Room	5			
Charge Injection <sup>e</sup>	Q <sub>INJ</sub>	V <sub>g</sub> = 0 V, R <sub>g</sub> = 0 Ω, C <sub>L</sub> = 1 nF	Room		15		pC
Off Isolation <sup>e</sup>	OIRR	R <sub>L</sub> = 50 Ω, C <sub>L</sub> = 5 pF f = 1 MHz	Room		- 56		dB
Channel-to-Channel Crosstalk <sup>e</sup>	X <sub>TALK</sub>		Room		- 80		
Source Off Capacitance <sup>e</sup>	C <sub>NO(off)</sub> C <sub>NC(off)</sub>	f = 1 MHz	Room		53		pF
Drain Off Capacitance <sup>e</sup>	C <sub>COM(off)</sub>		Room		42		
Channel On Capacitance <sup>e</sup>	C <sub>COM(on)</sub>		Room		92		

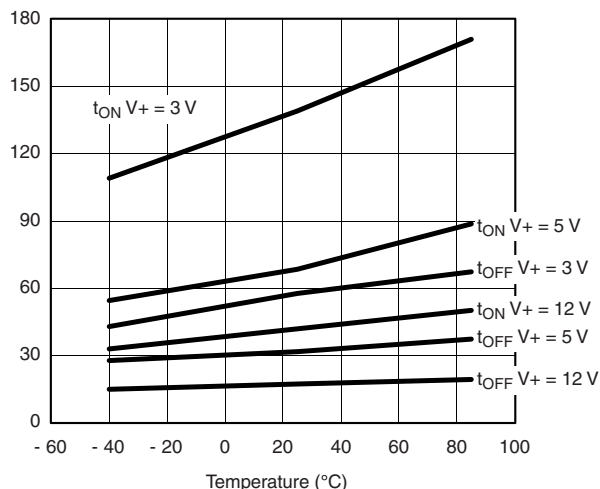
Notes:

- Leakage parameters are guaranteed by worst case test conditions and not subject to production test.
- Room = 25 °C, Full = as determined by the operating temperature suffix.
- Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.
- The algebraic convention whereby the most negative value is a minimum and the most positive a maximum, is used in this data sheet.
- Guaranteed by design, not subject to production test.
- $V_{IN}$  = input voltage to perform proper function.

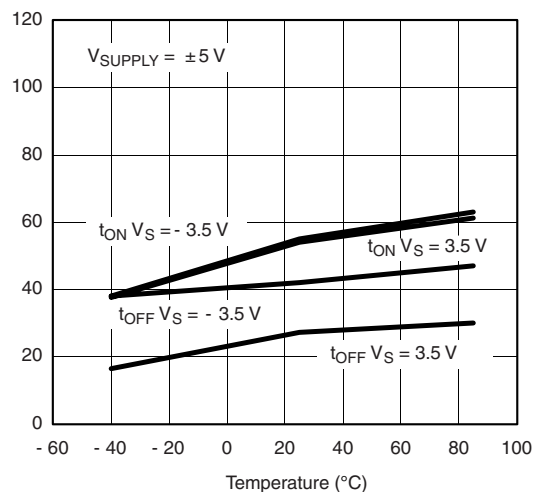
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted

 **$R_{ON}$  vs.  $V_{COM}$  and Supply Voltage**

 **$R_{ON}$  vs. Analog Voltage and Temperature**

 **$R_{ON}$  vs. Analog Voltage and Temperature**

**Supply Current vs. Temperature**

**Leakage Current vs. Analog Voltage**

**Switching Current vs. Input Switching Frequency**

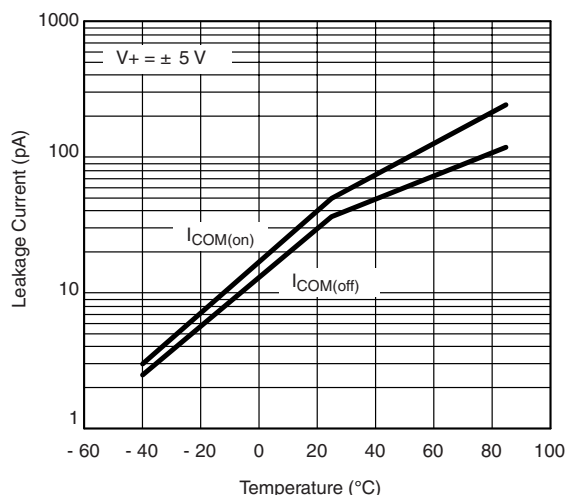
## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



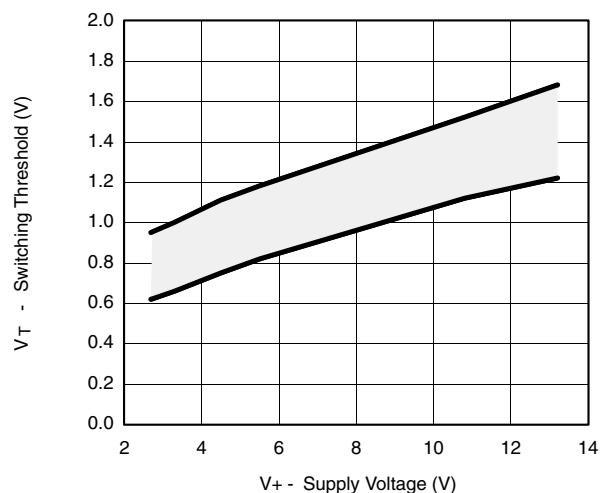
Switching Time vs. Temperature and Single Supply Voltage



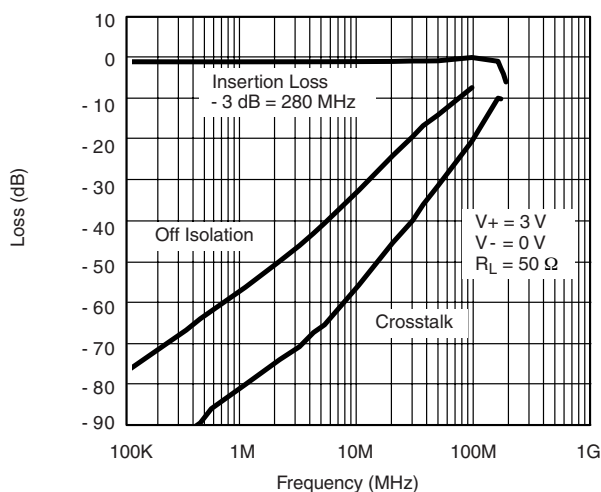
Switching Time vs. Temperature and Dual Supply Voltage



Leakage Current vs. Temperature



Switching Threshold vs. Supply Voltage



Insertion Loss, Off Isolation and Crosstalk vs. Frequency



## SCHEMATIC DIAGRAM Typical Channel

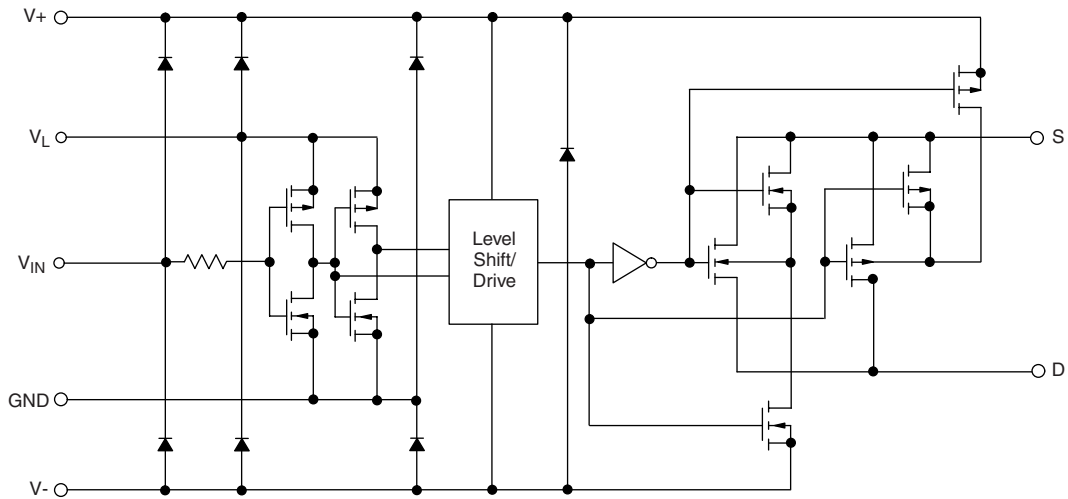
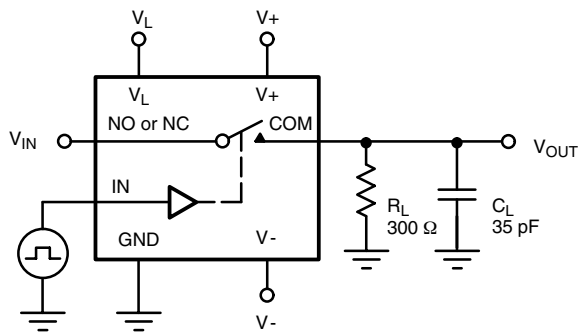


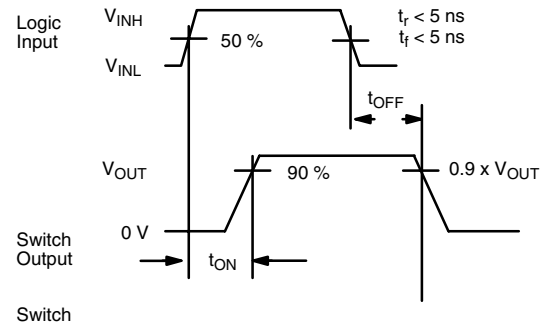
Figure 1.

## TEST CIRCUITS



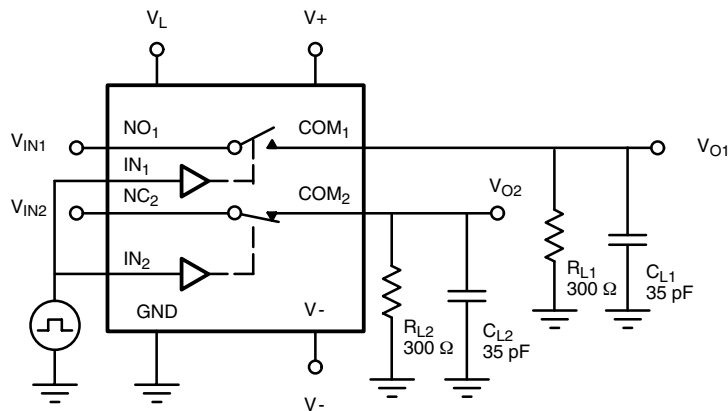
$C_L$  (includes fixture and stray capacitance)

$$V_{OUT} = V_{IN} \frac{R_L}{R_L + r_{ON}}$$



Note: Logic input waveform is inverted for switches that have the opposite logic sense control

Figure 2. Switching Time



$C_L$  (includes fixture and stray capacitance)

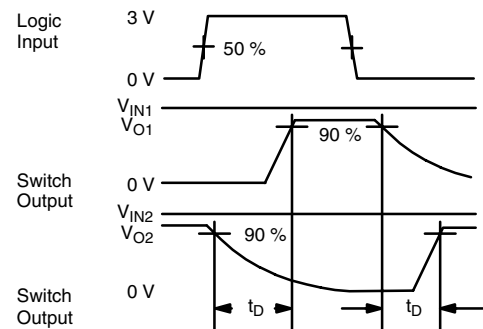


Figure 3. Break-Before-Make (DG9426)

## TEST CIRCUITS

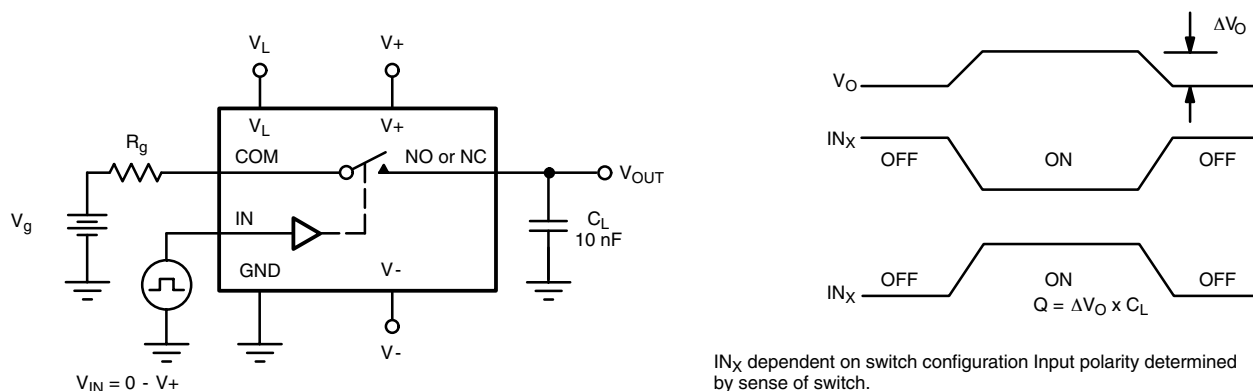


Figure 4. Charge Injection

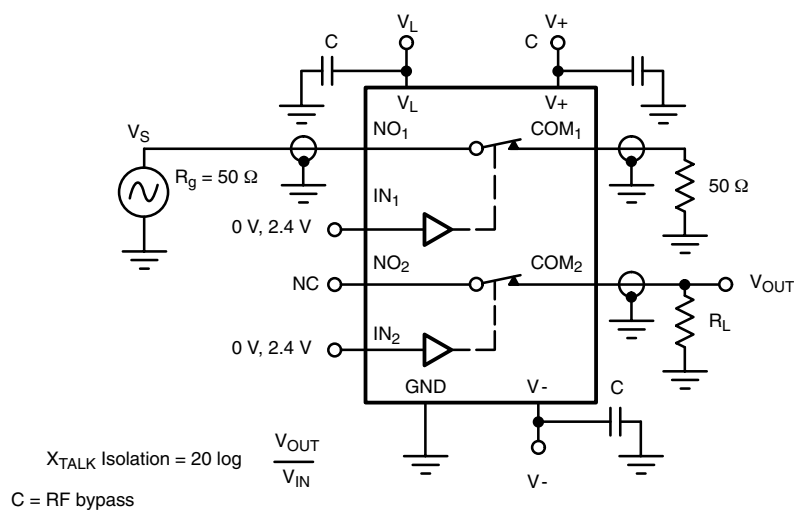


Figure 5. Crosstalk

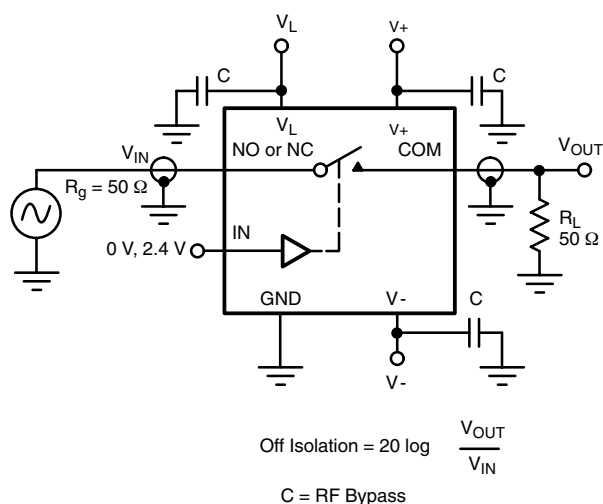


Figure 6. Off-Isolation

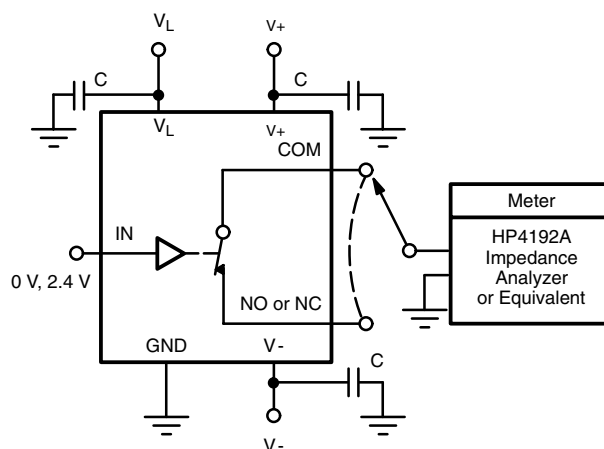
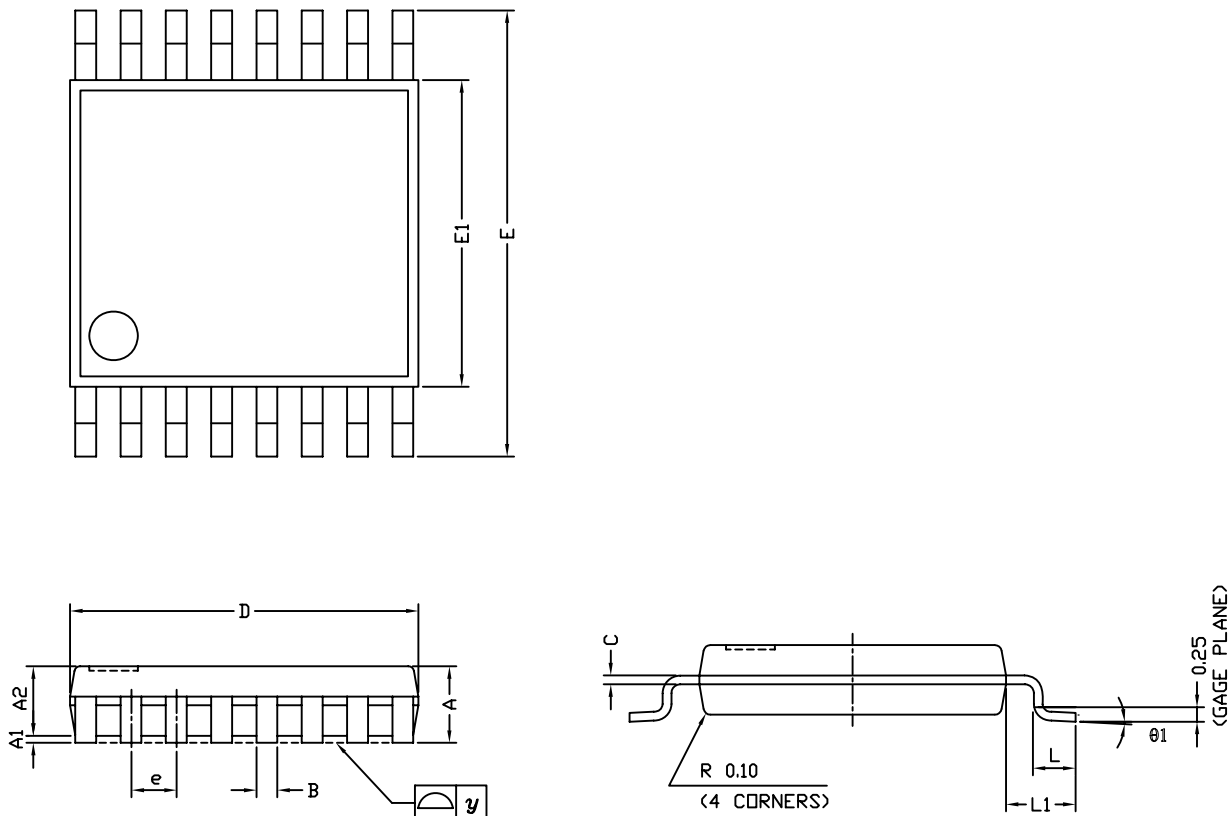


Figure 7. Source/Drain Capacitances

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see [www.vishay.com/ppg?71807](http://www.vishay.com/ppg?71807).

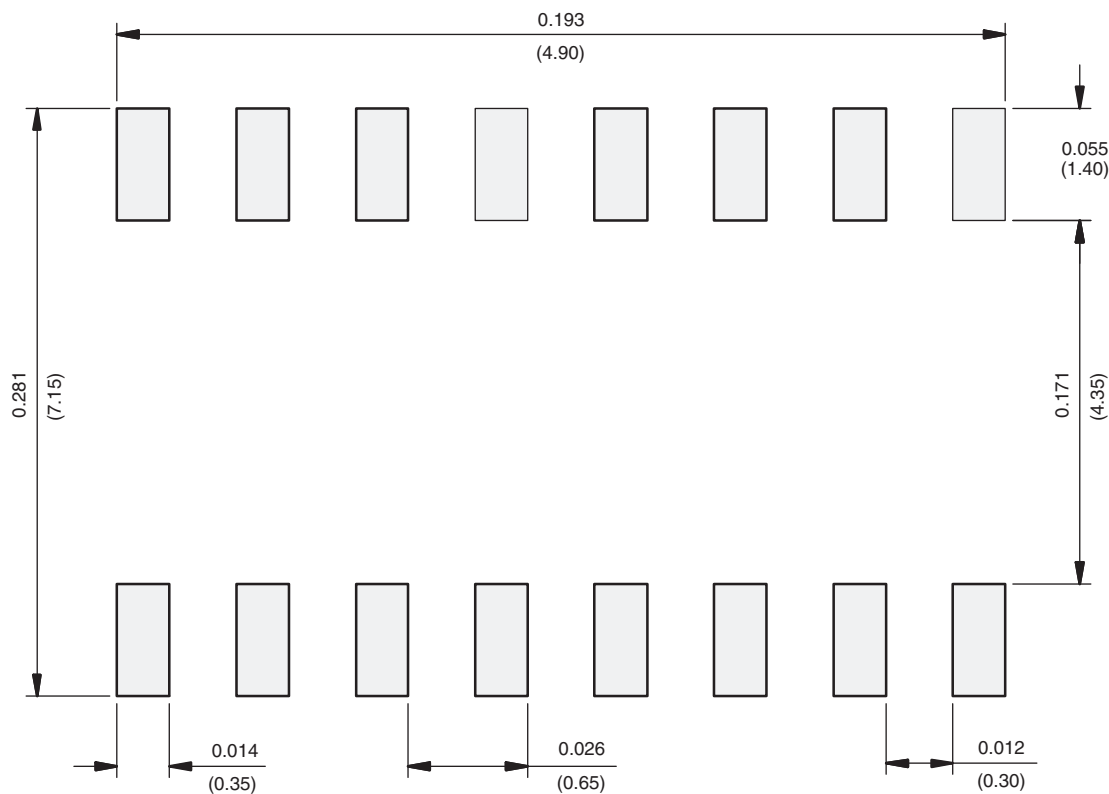
## TSSOP: 16-LEAD



Symbols	DIMENSIONS IN MILLIMETERS		
	Min	Nom	Max
A	-	1.10	1.20
A1	0.05	0.10	0.15
A2	-	1.00	1.05
B	0.22	0.28	0.38
C	-	0.127	-
D	4.90	5.00	5.10
E	6.10	6.40	6.70
E1	4.30	4.40	4.50
e	-	0.65	-
L	0.50	0.60	0.70
L1	0.90	1.00	1.10
y	-	-	0.10
θ1	0°	3°	6°
ECN: S-61920-Rev. D, 23-Oct-06			
DWG: 5624			



## RECOMMENDED MINIMUM PAD FOR TSSOP-16



Recommended Minimum Pads  
Dimensions in inches (mm)



## Disclaimer

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## Material Category Policy

**Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.**

**Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.**